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MOBILE LIQUID CRYSTAL DISPLAY GROUP II
SHARP CORPORATION

SPECIFICATION

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APPLICABLE GROUP Mobile LCD Group II

DEVICE SPECIFICATION FOR

CG-Silicon TFT-LCD module

MODEL No. LS037V7DW03

CUSTOMER'S APPROVAL

DATA

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PRESENTED

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(1) Application

This literature applies to LS037V7DW03.

(2) Overview

This module is a color transflective and active matrix LCD module incorporating CG-Silicon TFT (Continuous Grain-Silicon Thin Film Transistor). It is composed of a color TFT-LCD panel, driver ICs (with control Function), an FPC(with DC-DC Converter), a back light and a back sealed casing.

It is composed control circuit. Graphics and texts can be displayed on a 480×3×640 dots panel with 262,144 colors by supplying.

This LCD module has multi resolution and multi colors functions. A resolution mode is selective in VGA (480H×640V) or QVGA (240H×320V). A Color mode is selective in 262,144 colors (18bit RGB) or 8 colors (3bit RGB).

It is a wide viewing-angle-mode (Vertical viewing angle: (±80°) Horizontal viewing angle: (±80°), CR ≥ 5).

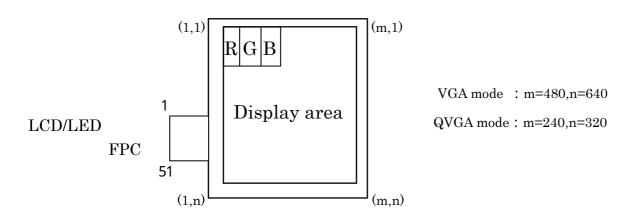
(3) Mechanical specifications

Table 1

Parameter	Specifications	Units	Remarks
Screen size (Diagonal)	9.4 [3.7"] Diagonal	cm	Temans
Display active area	56.16 (H) ×74.88 (V)	mm	
	480(H)×640(V)		
Pixel format	(1 pixel = R+G+B dots)	pixels	
Dot pitch	0.039 (H)×0.117 (V)	mm	
Pixel configuration	R,G,B vertical stripe		
Display mode	Normally Black		
Unit outline dimension	65.0(W)×89.2(H)×3.6(D)	mm	【Note3-1】
Mass	38	g	

[Note 3-1] Excluding protrusion. For detailed measurements and tolerances, please refer to Fig. 1.

(4) Pixel configuration



(5) Input/Output terminal

5-1) TFT-LCD panel and Backlight driving section

Table2

Pin No.	Symbol	I/O	Description	Remarks
1	LED+	-	LED power supply(High Voltage)	[Note5-1]
2	NC	-		
3	LED-	_	LED power supply(Low Voltage)	
4	NC	_		
5	NC	_		
6	NC	_		
7	NC	_		
8	NC	-		
9	GND	-	Ground	
10	RESB	I	Reset signal	[Note5-2]
11	GND	_	Ground	
12	MO	I	Selection for resolution(VGA/QVGA)	[Note5-3]
13	UD	I	Selection for vertical scanning direction	[Note5-4]
14	LR	I	Selection for horizontal scanning direction	[Note5-5]
15	INI	I	Power on control	[Note5-2]
16	DEN	I	Data enable signal	[Note5-6]
17	GND	-	Ground	
18	VSYNC	I	Vertical synchronizing signal	
19	GND	_	Ground	
20	HSYNC	I	Horizontal synchronizing signal	
21	GND	_	Ground	
22	CLKIN	I	System clock signal	
23	GND	-	Ground	
24	VCC	-	Power supply(3.3V)	[Note5-2]
25	VCC	-	Power supply(3.3V)	[Note5-2]
26	VCC	_	Power supply(3.3V)	[Note5-2]
27	GND	-	Ground	
28	B5	I	Blue data signal(MSB)	
29	B4	I	Blue data signal	
30	В3	I	Blue data signal	
31	B2	I	Blue data signal	
32	B1	I	Blue data signal	
33	В0	I	Blue data signal(LSB)	
34	GND	-	Ground	
35	G5	I	Green data signal(MSB)	
36	G4	I	Green data signal	

Pin No.	Symbol	I/O	Description	Remarks
37	G3	I	Green data signal	
38	G2	I	Green data signal	
39	G1	I	Green data signal	
40	G0	I	Green data signal(LSB)	
41	GND	-	Ground	
42	R5	I	Red data signal(MSB)	
43	R4	I	Red data signal	
44	R3	I	Red data signal	
45	R2	I	Red data signal	
46	R1	I	Red data signal	
47	R0	I	Red data signal(LSB)	
48	GND	-	Ground	
49	SMPSYNC	I	Selection for Vertical/ Horizontal synchronizing signal timing(clock timing)	[Note5-7]
50	SMPDATA	I	Selection for Red, Green and Blue data signal timing (clock timing)	[Note5-7]
51	ID1	-	Ground	

[Note5-1] When superfluous current flows, please intercept current with a fuse etc.

[Note5-2] See section(7-1)-(A) "* Cautions when you turn on or off the power supply".

[Note5-3] Selection for resolution mode

МО	Resolution
Low	VGA(480RGB×640)
High	QVGA(240RGB×320)

[Note5-4] Selection for vertical scanning direction

U/L	Scanning direction (Pixel configuration)
	Conventional scanning (X , 1)
High	↓ ↓
	(X,Y)
	Inverted scanning (X, 1)
Low	↑
	(X,Y)

VGA mode: Y=640, QVGA mode: Y=320

[Note5-5] Selection for horizontal scanning direction

LBR	Scanning direction (Pixel configuration)
High	Conventional scanning $(1,Y) \rightarrow (X,Y)$
Low	Inverted scanning $(1,Y) \leftarrow (X,Y)$

VGA mode: X=480, QVGA mode: X=240

[Note5-6]

DEN makes it possible to take effective data timing. Horizontal Data Sampling Timing is shown in 7-2) Timing Characteristics of input signals.

[Note5-7] Selection for synchronizing signal and data signal timing(clock timing)

SMPSYNC	Selection for Vertical/ Horizontal synchronizing signal timing(clock timing)	SMPDATA	Selection for Red,Green and Blue data signal timing(clock timing)
High	Rise edge of clock(CLKIN)	High	Rise edge of clock(CLKIN)
Low	Fall edge of clock(CLKIN)	Low	Fall edge of clock(CLKIN)

(6) Absolute Maximum Ratings

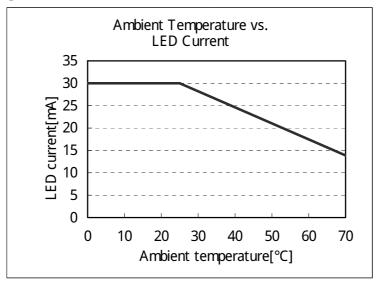
Table 3

Parameter	Symbol	Condition	Ratings	Unit	Remark
Power supply (COG driver / Digital)	VSHD	Ta=25℃	-0.3 ~ +4.0	V	
Input voltage (Digital)	VID	Ta=25℃	-0.3 ~ VSHD+0.3	V	[Terminal]
Operating temperature(Panel surface)	Topp	_	-10 ~ 60	°	【Note6-1】
Storage temperature	Tstg	_	-20 ~ 70	°C	【Note6-1】
LED current	I_{L}	Ta=25℃	30	mA	【Note6-2】

[Terminal] INI,VSYNC,HSYNC,MO,UD,LR,CLK,R0 ~ R5,G0 ~ G5,B0 ~ B5,DEN,RESB

【Note6-1】 Humidity: 95%RH Max.(at Ta ≤ 40°C). Maximum wet-bulb temperature is less than 39°C (at Ta > 40°C). Condensation of dew must be avoided.

[Note6-2] (Provisional plan) LED current should be as per below figure.



(7) Electrical characteristics

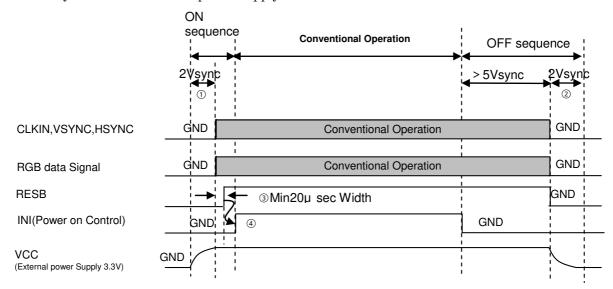
7-1) Recommended operating conditions

A) TFT-LCD panel driving section

Table4 GND=0V

Parameter		Symbol	Min.	Тур.	Max.	Unit	Remarks
Supply voltage for COG driver	1100		+3.0	+3.3	+3.6	V	
Input voltage (L	VILS	GND	1	0.2VSHD	V	【Note 7-1】	
Input voltage (H	ligh)	VIHS	0.8VSHD	ī	VSHD	V	【Note 7-1】
Input current (I	IILS	-	ī	10	μA	【Note 7-1】	
Input current (H	IIHS	-	-	10	μA	【Note 7-1】	

* Cautions when you turn on or off the power supply



- (1) After VCC is ON ,please make sure to start HVIF(CLK,HSYNC,VSYNC,RGB data signal) synchronized signal before INI(Power on control) becomes High.
- (2) Please keep HVIF(CLK,HSYNC,VSYNC,RGB data signal) synchronized signal High for more than 5 vertical period after INI becomes Low to shut down VCC.
- (3) Stabilize VCC(+3.3V) within double vertical periods.
- (4) VCC is stabilized to GND within double vertical periods.
- (5) When the power supply is on again after Power Supply Off sequence ,please put the RESB signal before Power Supply On sequence. RESB signal needs LOW level more than 20µsec after VCC(+3.3V) ON.
- (6) Please Set RESB signal before INI Signal.

[Note 7-1] INI,VSYNC,HSYNC,MO,UD,LR,CLK,R0 \sim R5,G0 \sim G5,B0 \sim B5,DEN,RESB terminals are applied. Each voltage should be kept to satisfy absolute maximum ratings.

If the applied voltage goes beyond absolute maximum ratings, the LCD module may be broken eternally.

B) Back light driving section

Table 5 Ta=25

Parameter	Symbol	MIN	TYP	MAX	Units	Remarks terminal
LED voltage(VL)	V_{L}	ı	27.9	31.5	V	[Note 7-2]
LED current(IL)	${ m I}_{\sf L}$	ı	16	20	mA	
Power consumption	W_{L}	ı	446.4	630	mW	【Note 7-3】

[Note 7-2] $V_L(TYP)$ at $I_L(16mA)$. $V_L(MAX)$ at $I_L(20mA)$.

[Note 7-3] Calculated reference value. $WL=(V_1 \times I_1)$

Table 6

AC Characteristics Parameter Symbol MODE Min. Max. Unit Note Typ. VGA 38 39.7 41.7**CLK Period** $t_{\rm CLK}$ ns **QVGA** 152 158.8 167 CLKCLK Low Width $t_{\rm CLKL}$ 15 CLK High Width t_{CLKH} 15 ns R0 ~ R5, Data setup time 10 $\mathrm{t_{DS}}$ ns $G0 \sim G5$, Data hold time t_{DH} 10 $\mathrm{B0} \sim \mathrm{B5}$ nsVGA 480 Pulse width of DEN t_{HHW} QVGA 240VGA 648 Period of HSYNC CLK t_{HS} **QVGA** 324Pulse width of HSYNC 2 CLK $t_{
m hsw}$ **HSYNC** HSYNC setup time 10 t_{HSYS} nsHSYNC hold time 10 $t_{\rm HSYH}$ ns VGA 28 78 166 Horizontal Back Porch CLK t_{HBP} **QVGA** 14 38 82 VGA 0 88 138 Horizontal Front Porch CLK ${
m t}_{
m HFP}$ **QVGA** 0 44 68 Period of VSYNC tvs57 59.94 63 HzVGA 648 Period of VSYNC **HCYC** tvs QVGA 324 VSYNC Pulse width of VSYNC **HCYC** 1 $t_{\rm vsw}$ VSYNC setup time 10 tvsys ns VSYNC hold time 10 tvsyh nsVSYNC-HSYNC [Note 7-4] t_{VHD} 0 HCYC-2 CLK phase difference Note 7-5 Input Signal 1 Rising Time 5 ns ${
m t_{RISE1}}$ 5 [Note 7-5] Input Signal 1 Falling Time ${
m t}_{
m FALL1}$ ns [Note 7-6] 5 Input Signal 2 Rising Time t_{RISE2} us [Note 7-6] Input Signal 2 Falling Time tfall2 5 μs [Note 7-7] Reset Pulse Width 20 t_{RESW} μs

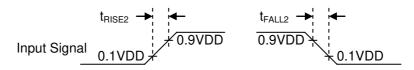
[Note 7-4] HCYC = HSYNC Period(VGA:Typ.648CLK, QVGA:Typ.324CLK)

[Note 7-5] VSYNC, HSYNC, CLK, R0 ~ R5, G0 ~ G5, B0 ~ B5, DEN terminals are applied.



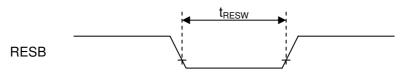
【Fig 7-1 Input Signal Rising/Falling Timing】

[Note 7-6] INI,RESB terminals are applied.



【Fig 7-2 Input Signal Rising/Falling Timing】

[Note 7-7] Reset Signal Timing chart



【Fig 7-3 Reset Timing Signal】

7-3)Power consumption

Measurement condition: Vsync=59.94Hz, Hsync=38.84kHz, CLK=25.17MHz, Ta=25°C (VGA Mode)

Table 7 (when conventional scan mode)
Parameter Sym Conditions MIN TYP MAX Unit Remarks

ParameterSymConditionsMINTYPMAXUnitRemarksVSHD Total (Digital+Analog)ISHDVSHD=+3.3V-4575mA[Note7-8]

[Note 7-8] White Pattern

[Portrait VGA Mode Timing Chart]

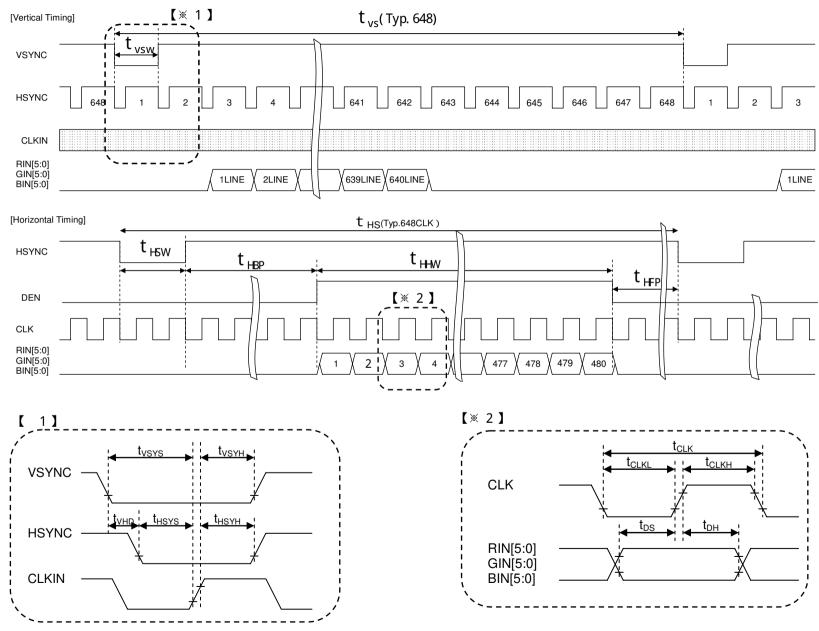


Fig 7-3 LCDIF signal timing in Portrait VGA mode

[Portrait QVGA Mode Timing Chart]

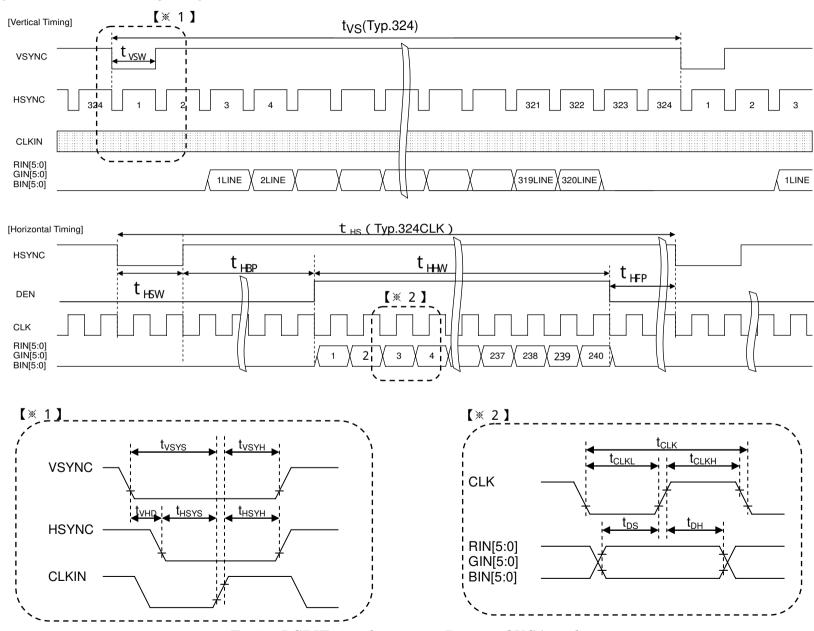


Fig 7-4 LCDIF signal timing in Portrait QVGA mode

(8) Input Signals, Basic Display Color and Gray Scale of Each Color

Table 8

18bit RGB color display mode

	Colors &	Data signal																		
	Gray scale	Gray Scale	R0	R1	R2	R3	R4	R5	G0	G1	G2	G3	G4	G5	В0	B1	B2	В3	B4	В5
	Black	_	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	_	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
E	Green	_	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
asic	Cyan	_	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
Basic color	Red	_	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
ıC	Magenta	_	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	_	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0	仓	GS1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray Scale of red	Darker	GS2	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Sca	仓	V			1							l					1	V		
le o	Û	\downarrow			1	/					\	ν <u> </u>					1	\		
frec	Brighter	GS61	1	0	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Û	GS62	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red	GS63	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gr	仓	GS1	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0
ay S	Darker	GS2	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
cale	仓	↓			1							l					1	V		
Gray Scale of green	Û	→			1	<u> </u>					\	<u>ν</u>					1	ν <u> </u>		
gree	Brighter	GS61	0	0	0	0	0	0	1	0	1	1	1	1	0	0	0	0	0	0
n	Û	GS62	0	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0
	Green	GS63	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gr	仓	GS1	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
ay s	Darker	GS2	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0
Gray Scale of bleu	仓	V			1				↓					↓						
e of	Û	↓			1	<u> </u>					\	<u>ا</u>			V					
bler	Brighter	GS61	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1
1	Û	GS62	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1
	Bleu	GS63	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

^{0:} Low level voltage

Each basic color can be displayed in 64 gray scales from 6 bit data signals. According to the combination of total 18 bit data signals, the 262,144-color display can be achieved on the screen.

^{1:} High level voltage

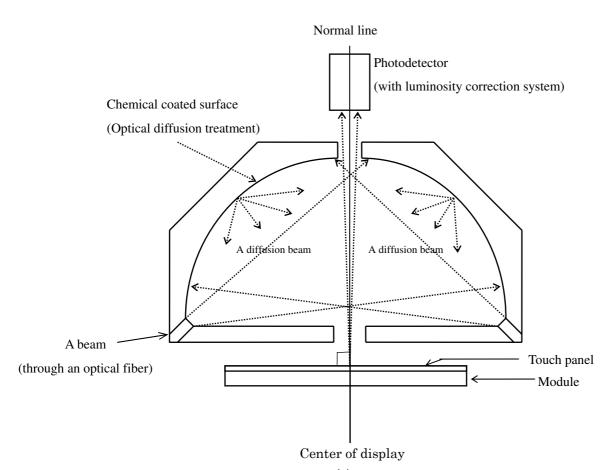
9-1) Not driving the Back light condition

Table 9				Ta=25°C

1a-25 (1a-20 C		
Par	rameter	Symbol	Condition	Min	Тур	Max	Unit	Remarks
Viewing angle		021,22		30	40	-	degree	[Note 9-1,2]
range		θ11, 12	CR ≧ 1.2	30	40	-	degree	
Contrast r	atio	CRmax	θ=0°	-	2	-		[Note 9-2,4]
Response	Rise	τr		-	10	20	ms	
time	Fall	τd		-	10	20	ms	[Note 9-3]
White chromaticity		X	θ=0°	0.25	0.30	0.35		
		У		0.30	0.35	0.40		[Note 9-4]
Reflection ratio		R	θ=0°	2	4	-	%	[Note 9-5]

^{*} The measuring method of the optical characteristics is shown by the following figure.

^{*} A measurement device is Otsuka luminance meter LCD5200.(With the diffusion reflection unit.)



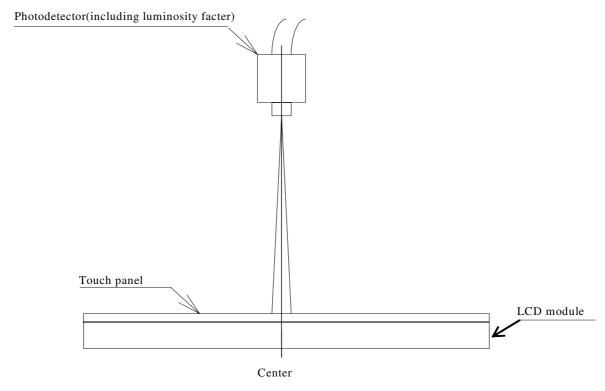
Measuring method (a) for optical characteristics

Table 10 Ta=25°C

1a-25 C								
Par	ameter	Symbol	Condition	Min	Тур	Max	Unit	Remarks
Viewing angle range		θ21,22	CD > #	40	80	-	degree	[Note 9-1,2,6]
		θ11,12	CR ≧ 5	40	80	-	degree	
Contrast ratio		Crmax		100	200	-		[Note 9-2]
Response	Rise	τr	$\theta = 0$ °		15	20	ms	[Note 9-3]
time	Fall	τd			20	30	ms	
White chromaticity		X		0.26	0.31	0.36		
		Y		0.28	0.33	0.38		
NTSC ratio		S		-	35	-	%	
Brightness		Y	$\theta = 0_{\circ}$	130	200	-	cd/m²	I _L =16mA
Uniformity		U	$\theta = 0$ °	60	•	_	%	[Note 9-7]

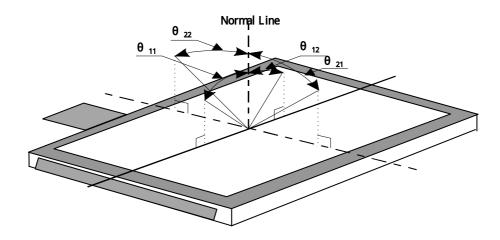
^{*} The measuring method of the optical characteristics is shown by the following figure.

^{*} A measurement device is TOPCON luminance meter SR-3.(Viewing cone 1)



[Measuring method for optical characteristics]

[Note 9-1] Viewing angle range is defined as follows.



[Definition for viewing angle]

[Note 9-2] Definition of contrast ratio:

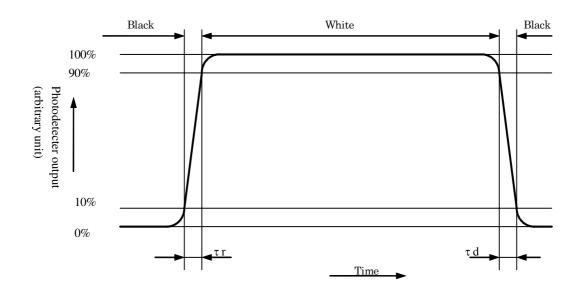
The contrast ratio is defined as follows:

Contrast ratio (CR) = $\frac{\text{Photodetecter output with all pixels white}(\text{GS63})}{\text{Photodetecter output with all pixels black}(\text{GS0})}$

VCOMAC=5.0Vp-p

[Note 9-3] Definition of response time:

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".



[Note 9-4] A measurement device is Minolta CM-2002.

[Note 9-5] Definition of reflection ratio

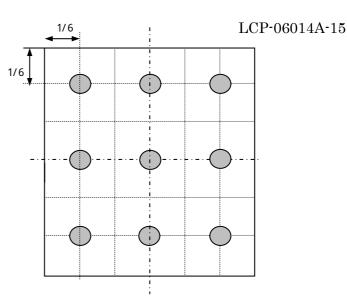
 $Reflection\ ratio = \frac{Light\ detected\ level\ of\ the\ reflection\ by\ the\ LCD\ module}{Light\ detected\ level\ of\ the\ reflection\ by\ the\ standard\ white\ board}$

[Note 9-6] A measurement device is ELDIM EZContrast

[Note 9-7] Definition of Uniformity

 $Uniformity = \frac{Minimum\ Brightness}{Maximum\ Brightness} \times 100(\%)$

The brightness should be measured on the 9-point as shown in the right figure.



(10)Display quality

The display quality of the color TFT-LCD module shall be in compliance with the Incoming Inspection Standards TFT-LCD.

(11)Mechanical characteristics

11-1) External appearance

See Fig. 1 Outline Dimension

11-2) FPC (for LCD panel) characteristics

Specific connector

LCD-FPC: HIROSE FH23-51S-0.3SHAW(05) (Bottom contact only)

(12) Handling Precautions

- 12-1) Insertion and taking out of FPCs
 - (1) Be sure insert and take out of the FPC into the connector of the set after turning off the power supply on the set side.

12-2) Handling of FPCs

- (1) The FPC for LCD panel shall be bent only slit portion. The bending slit shall be bent uniformly on the whole slit portion with bending radius larger than 1.0mm, and only inner side (back side of the module). Don't bend it outer side (display surface side).
- (2) Don't give the FPCs too large force, for example, hanging the module with holding FPC. Moreover, Do not put stress on the components mounted on FPC to avoid failure of the components.

12-3) Installation of the module

(1) On mounting the module, be sure to fix the module on the same plane. Taking care not to warp or twist the module.

12-4)Precaution when mounting

- (1) If water droplets and oil attaches to it for a long time, discoloration and staining occurs. Wipe them off immediately.
- (2) Glass is used for the TFT-LCD panel. If it is dropped or bumped against a hard object, it may be broken. Handle it with sufficient care.
- (3) As the CMOS IC is used in this module, pay attention to static electricity when handling it. Take a measure for grounding on the human body.

12-5)Others

- (1) The liquid-crystal is deteriorated by ultraviolet rays. Do not leave it in direct sunlight and strong ultraviolet rays for many hours.
- (2) If it is kept at a temperature below the rated storage temperature, it becomes coagulated and the panel may be broken. Also, if it is kept at a temperature above the rated storage temperature, it becomes isotropic liquid and does not return to its original state. Therefore, it is desirable to keep it at room temperature as much as possible.
- (3) If the LCD breaks, don't put internal liquid crystal into the mouth. When the liquid crystal sticks to the hands, feet and clothes, wash it out immediately.
- (4) Wipe off water drop or finger grease immediately. Long contact with water may cause discoloration or spots.
- (5) Observe general precautions for all electronic components.
- (6) Static image should not be displayed more than 5 minutes in order to prevent from occurrence of residual image.

(13)Reliability Test Conditions for TFT-LCD Module

Table 11

No.	Test items	Test conditions					
1	High temperature storage test	Ta=+70°C 240h					
2	Low temperature storage test	Ta=-20℃ 240h					
3	High temperature and	Tp=+40°C , 95%RH 240h					
	high humidity operating test	(But no condensation of dew)					
4	High temperature operating test	Tp=+60°C 240h					
5	Low temperature operating test	Tp=-10°C 240h					
6	Electro static discharge test	±200V • 200pF(0Ω) to Terminals(Contact)					
		(1 time for each terminals)					
7	Shock tset	980 m/s^2 , 6 ms					
		±X,±Y,±Z 3 times for each direction					
		(JIS C0041, A-7 Condition C)					
8	Vibration test	Frequency range: 10Hz ~ 55 ~ 10Hz					
		Stroke: 1.5 mm Sweep: 10Hz ~ 55Hz					
		X,Y,Z 2 hours for each direction (total 6 hours)					
		(JIS C0040,A- 10 Condition A)					
9	Heat shock test	Ta=- 20°C ~ +70°C / 5 cycles					
		(1h) (1h)					

[Note] Ta = Ambient temperature, Tp = Panel temperature

[Check items]

• Test No.1 ~ 9

In the standard condition, there shall be no practical problems that may affect the display function.

(14) Others

14-1)Indication of lot number

The lot number is shown on a label. Attached location is shown in Fig.1 (Outline Dimensions).

14-2) Used Regulation of Chemical Substances Breaking Ozone Stratum

Substances with the object of regulating: CFCS, Carbon tetrachloride, Halon

1,1,1-Trichloro ethane (Methyl chloroform)

- (a) This LCD module, Constructed part and Parts don't contain the above substances.
- (b) This LCD module, Constructed part and Parts don't contain the above substances in processes of manufacture.
- 14-3) If some problems arise about mentioned items in this document and other items, the user of the TFT-LCD module and Sharp will cooperate and make efforts to solve the problems with mutual respect and good will.

(15) Forwarding form (fig2)

- a) Piling number of cartons: 8
- b) Package quality in one cartons: 100 pcs
- c) Carton size: 575 mm × 360 mm × 225 mm
- d) Total mass of 1 carton filled with full modules: TBD

Conditions for storage

Environment

(1)Temperature : $0 \sim 40$ °C

(2) Humidity : 60%RH or less (at 40°C)

No dew condensation at low temperature and high humidity.

(3) Atmosphere : Harmful gas, such as acid or alkali which bites electronic

components and/or wires, must not be detected.

(4)Period : about 3 months

(5)Opening of the package : In order to prevent the LCD module from breakdown by

electrostatic charges, please control the room humidity over 50%RH and open the package taking sufficient countermeasures against electrostatic charges, such as

earth, etc.

